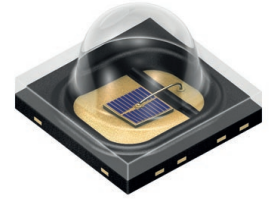


SFH 4715AS A01

OSLON® Black

OSLON Black Series (850 nm) - 80°



Applications

- Driver Monitoring / Seat Occupancy Detection
- Eye Tracking
- Gesture Recognition
- Safety and Security, CCTV

Features:

- Package: clear silicone
- Corrosion Robustness Class: 3B
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- IR lightsource with high efficiency
- Double stack emitter
- Low thermal resistance (Max. 9 K/W)
- Centroid wavelength 850 nm
- Optimized for high current pulse operation

Ordering Information

Type	Radiant intensity ¹⁾²⁾ $I_F = 1 \text{ A}; t_p = 10 \text{ ms}$ I_e	Radiant intensity ¹⁾ typ. $I_F = 1 \text{ A}; t_p = 10 \text{ ms}$ I_e	Ordering Code
SFH 4715AS A01	560 ... 900 mW/sr	770 mW/sr	Q65112A3325

Maximum Ratings

$T_A = 25\text{ °C}$

Parameter	Symbol		Values
Operating temperature	T_{op}	min. max.	-40 °C 125 °C
Storage temperature	T_{stg}	min. max.	-40 °C 125 °C
Junction temperature	T_j	max.	145 °C
Forward current	I_F	max.	1500 mA
Surge current $t_p \leq 450\ \mu\text{s}; D = 0.005$	I_{FSM}	max.	5 A
Reverse current ³⁾	I_R	max.	200 mA
Power consumption	P_{tot}	max.	5.5 W
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}	max.	2 kV

For the forward current and power consumption please see “maximum permissible forward current” diagram

Characteristics

$I_F = 1000 \text{ mA}$; $t_p = 10 \text{ ms}$; $T_A = 25 \text{ °C}$

Parameter	Symbol		Values
Peak wavelength	λ_{peak}	typ.	860 nm
Centroid wavelength	$\lambda_{\text{centroid}}$	typ.	850 nm
Spectral bandwidth at 50% $I_{\text{rel,max}}$ (FWHM)	$\Delta\lambda$	typ.	30 nm
Half angle	φ	typ.	40 °
Dimensions of active chip area	L x W	typ.	1 x 1 mm x mm
Rise time (10% / 90%) $I_F = 5 \text{ A}$; $R_L = 50 \text{ } \Omega$	t_r	typ.	10 ns
Fall time (10% / 90%) $I_F = 5 \text{ A}$; $R_L = 50 \text{ } \Omega$	t_f	typ.	15 ns
Forward voltage ⁴⁾ $I_F = 1 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	V_F	min. typ. max.	2.8 V 2.95 V 3.3 V
Forward voltage ⁴⁾ $I_F = 1.5 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	V_F	min. typ. max.	2.9 V 3.05 V 3.55 V
Forward voltage ⁴⁾ $I_F = 5 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	V_F	min. typ. max.	3.2 V 3.5 V 4.4 V
Reverse voltage ³⁾ $I_R = 20 \text{ mA}$	V_R	max.	1.2 V
Reverse voltage (ESD device) ³⁾	V_{RESD}	min.	5 V
Radiant intensity ¹⁾ $I_F = 1.5 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	I_e	typ.	1150 mW/sr
Total radiant flux ⁵⁾ $I_F = 1 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	Φ_e	typ.	1360 mW
Total radiant flux ⁵⁾ $I_F = 1.5 \text{ A}$; $t_p = 100 \text{ } \mu\text{s}$	Φ_e	typ.	2015 mW
Temperature coefficient of voltage	TC_V	typ.	-2 mV / K
Temperature coefficient of wavelength	TC_λ	typ.	0.3 nm / K
Thermal resistance junction solder point real ⁶⁾	$R_{\text{thJS real}}$	typ. max.	6.0 K / W 9.0 K / W

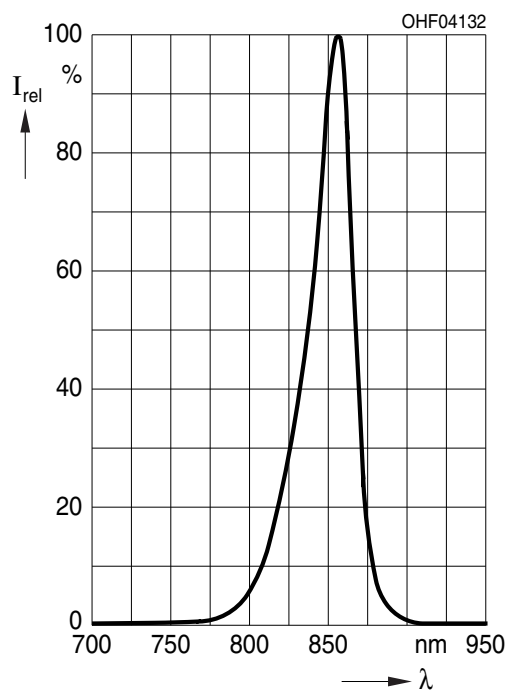
Brightness Groups

Group	Radiant intensity ¹⁾²⁾ $I_F = 1 \text{ A}; t_p = 10 \text{ ms}$ min. I_e	Radiant intensity ¹⁾²⁾ $I_F = 1 \text{ A}; t_p = 10 \text{ ms}$ max. I_e
DB	560 mW/sr	710 mW/sr
EA	710 mW/sr	900 mW/sr

Only one group in one packing unit (variation lower 1.6:1)

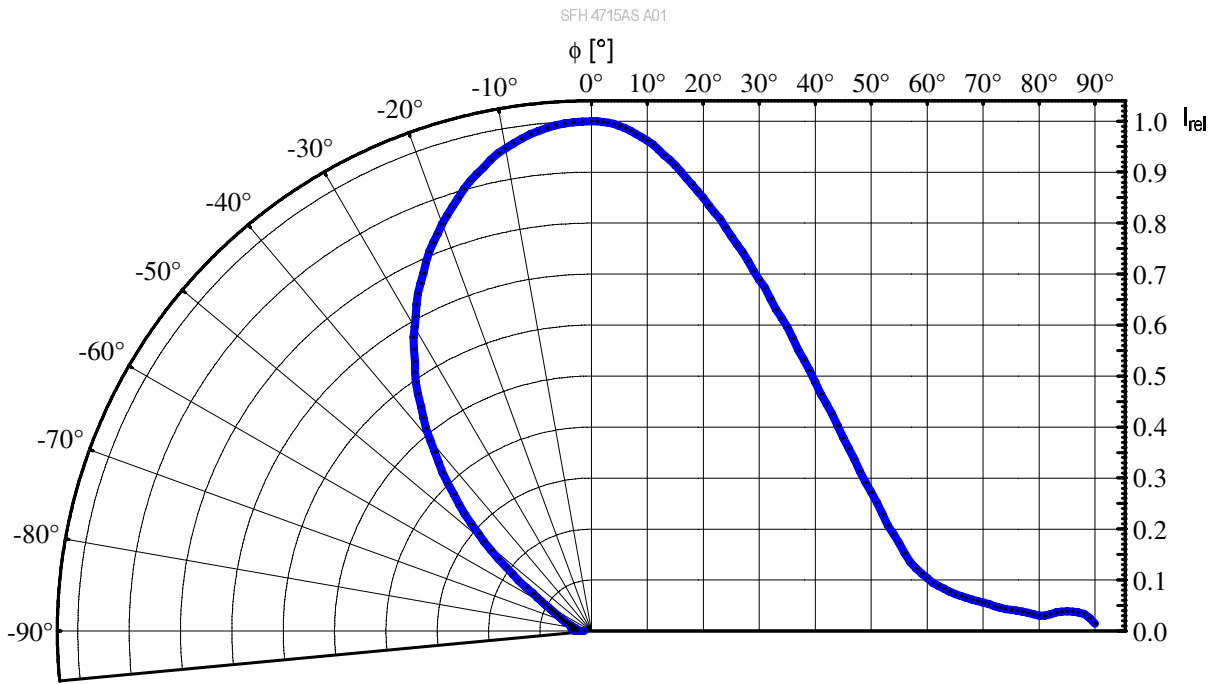
Relative Spectral Emission ^{7), 8)}

$I_{e,rel} = f(\lambda); I_F = 1000 \text{ mA}; t_p = 10 \text{ ms}$



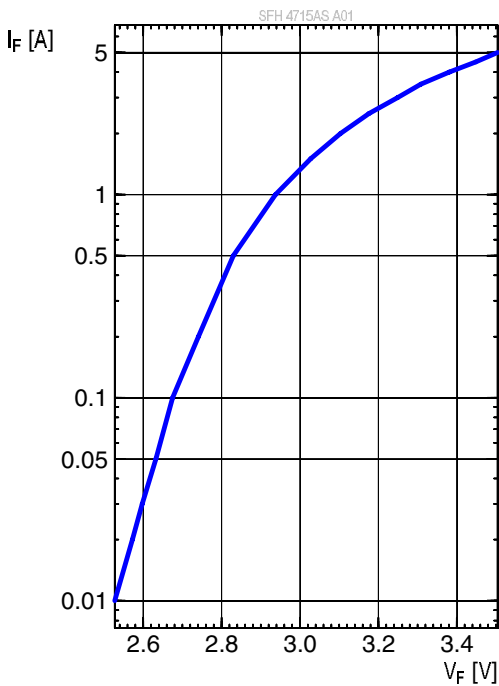
Radiation Characteristics (7), 8)

$I_{e,rel} = f(\varphi)$



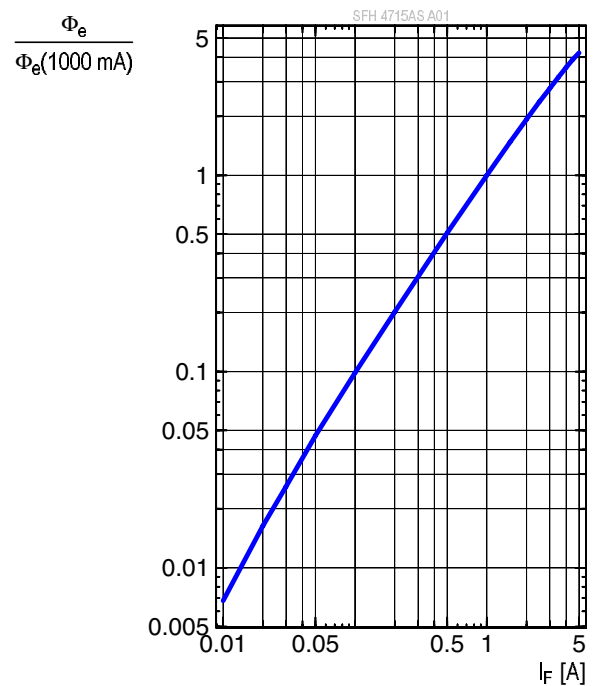
Forward current (7), 8)

$I_F = f(V_F)$; single pulse; $t_p = 10$ ms



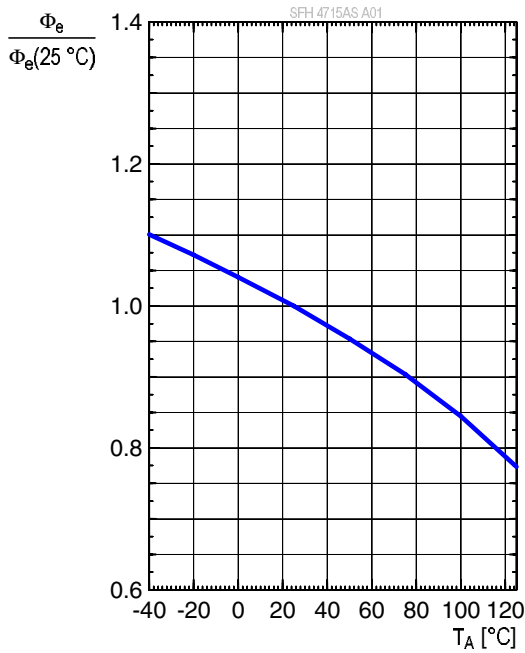
Relative Total Radiant Flux (7), 8)

$\Phi_e / \Phi_e(1000\text{mA}) = f(I_F)$; single pulse; $t_p = 10$ ms



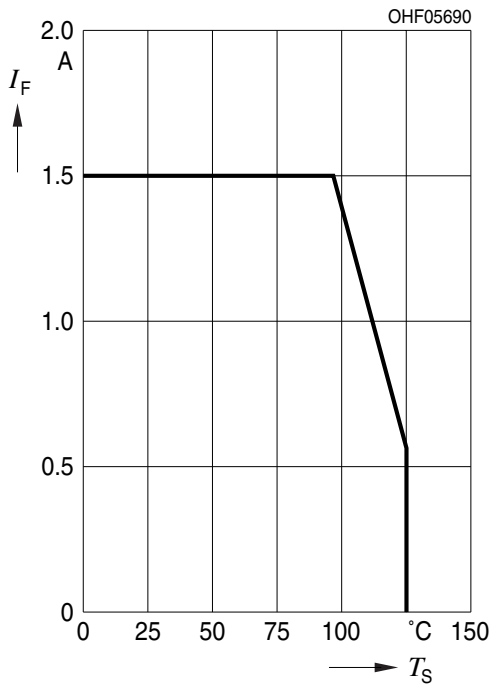
Relative Total Radiant Flux ⁷⁾

$\Phi_e = f(T_A)$; single pulse



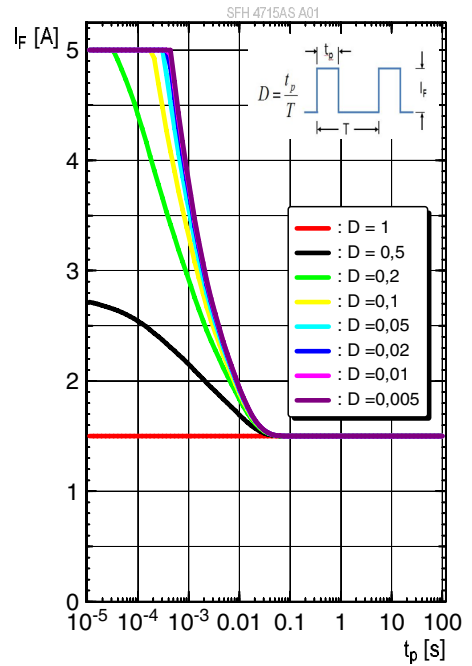
Max. Permissible Forward Current

$I_{F,max} = f(T_S)$; $R_{th_{js}} = 9\text{K/W}$ single pulse

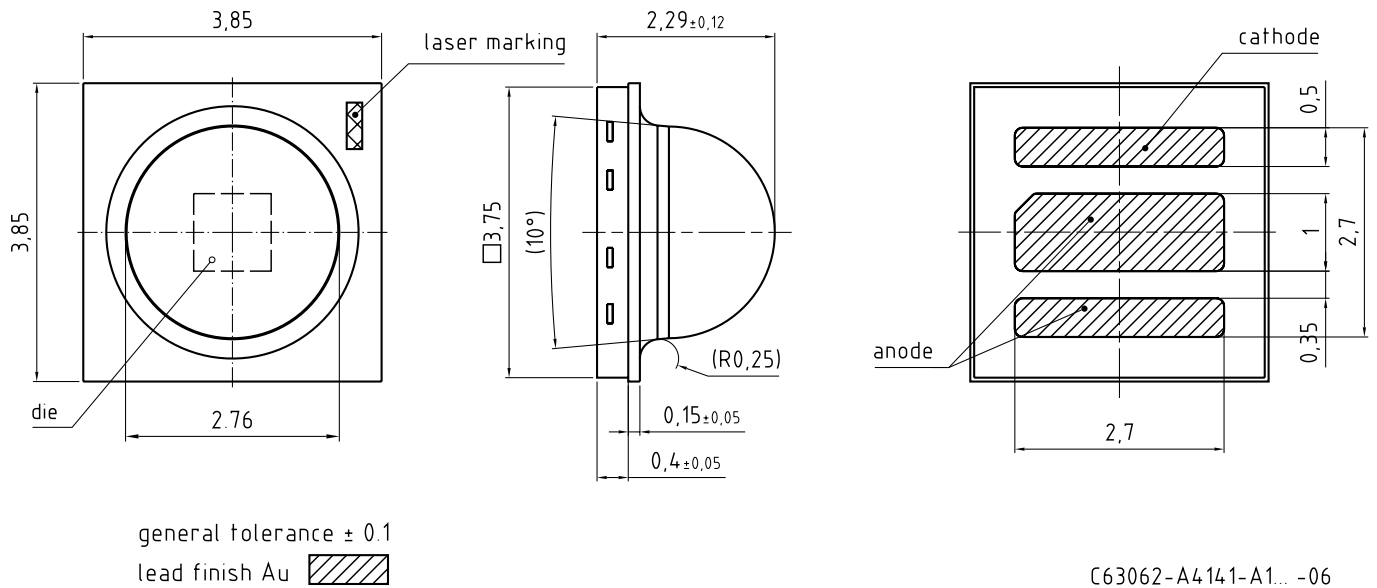


Permissible Pulse Handling Capability

$I_F = f(t_p)$; duty cycle $D = \text{parameter}$; $T_S = 85^\circ\text{C}$



Dimensional Drawing ⁹⁾



Further Information:

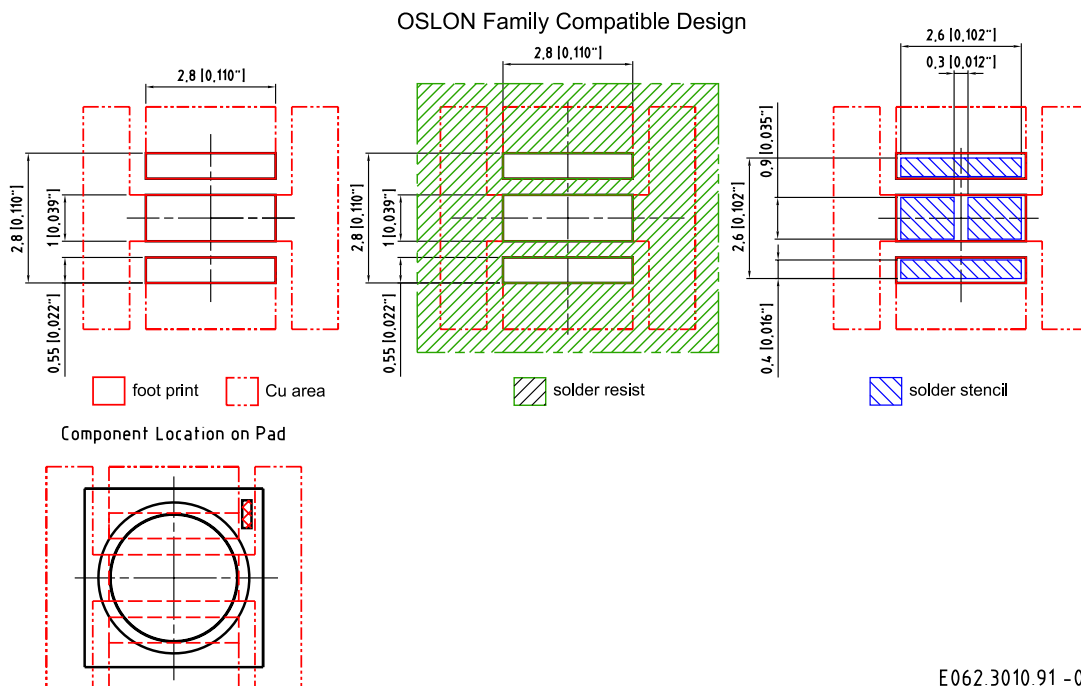
Approximate Weight: 31.0 mg

Package marking: Cathode

Corrosion test: Class: 3B
 Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC 60068-2-43)

ESD advice: The device is protected by ESD device which is connected in parallel to the Chip.

Recommended Solder Pad ⁹⁾

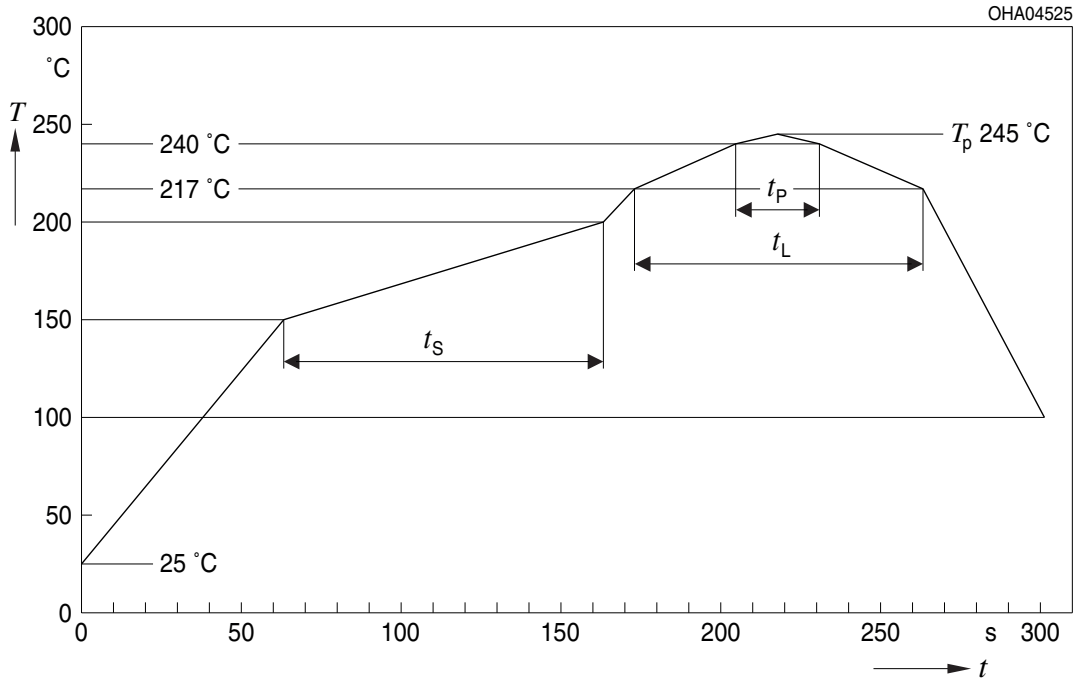


E062.3010.91-05

For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

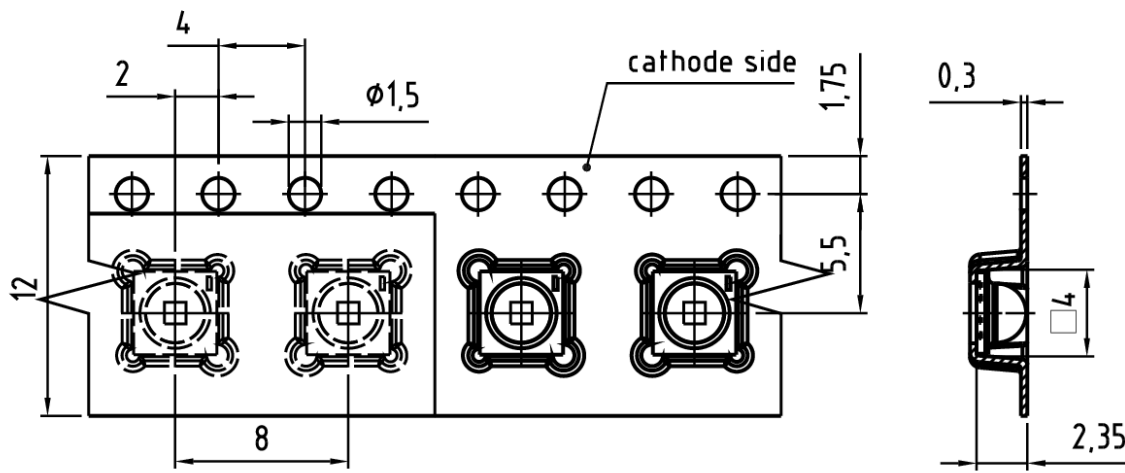


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat ^{*)} 25 °C to 150 °C			2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up rate to peak ^{*)} T_{Smax} to T_p			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_p		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	t_p	10	20	30	s
Ramp-down rate* T_p to 100 °C			3	6	K/s
Time 25 °C to T_p				480	s

All temperatures refer to the center of the package, measured on the top of the component

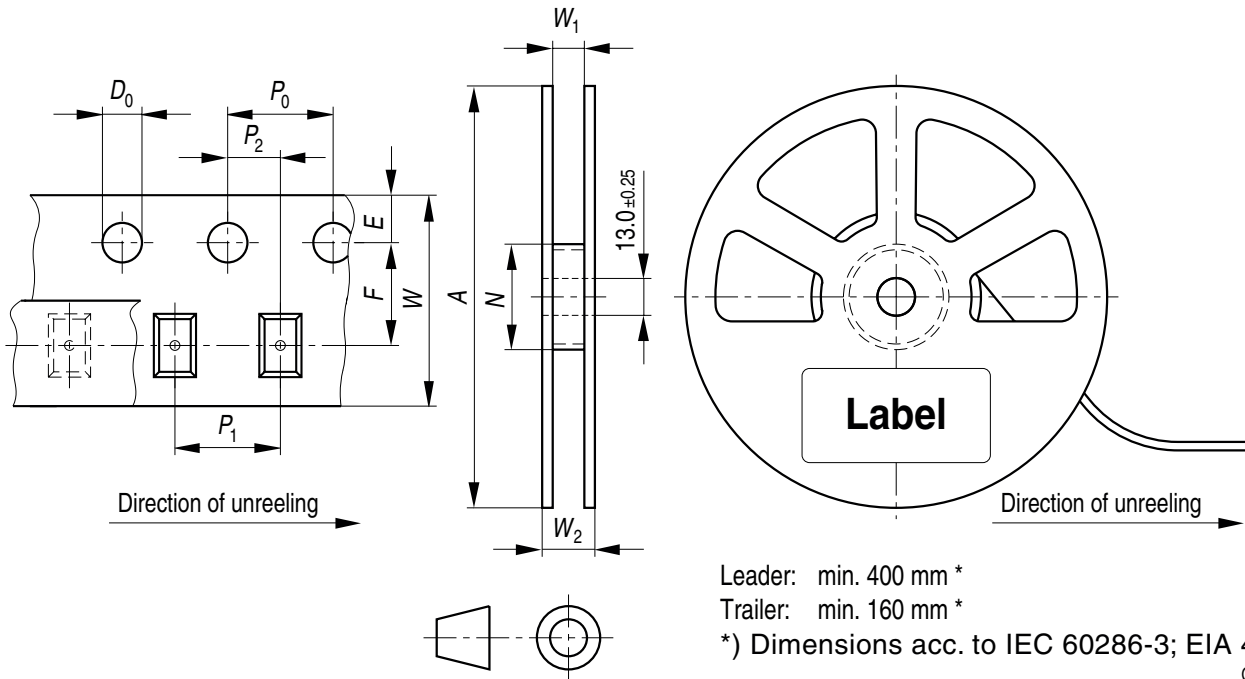
* slope calculation DT/Dt : Dt max. 5 s; fulfillment for the whole T-range

Taping ⁹⁾



C63062-A4141-B8 -02

Tape and Reel ¹⁰⁾



Leader: min. 400 mm *

Trailer: min. 160 mm *

*) Dimensions acc. to IEC 60286-3; EIA 481-D

OHAY0324

Reel Dimensions

A	W	N_{min}	W_1	W_{2max}	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	600

Barcode-Product-Label (BPL)

OSRAM Opto Semiconductors LX XXXX BIN1: XX-XX-X-XXX-X

RoHS Compliant

(6P) BATCH NO: 1234567890 ML Temp ST
X XXX °C X

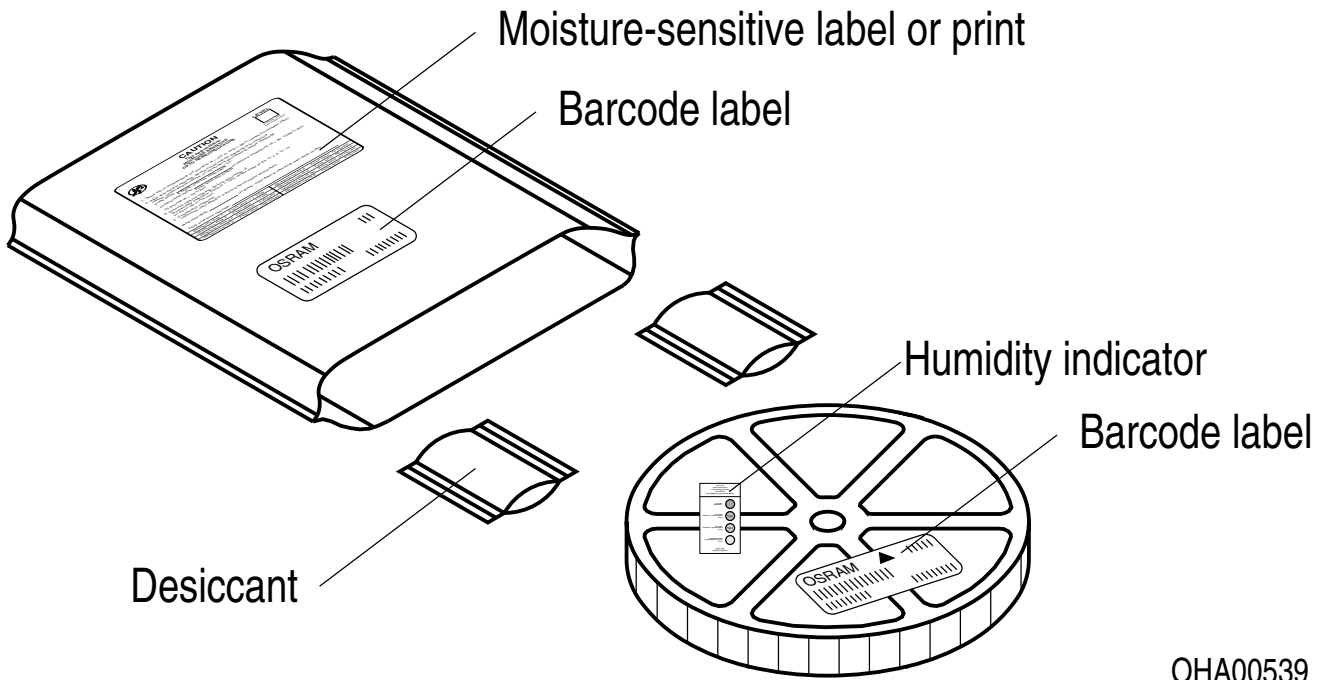
(1T) LOT NO: 1234567890 (9D) D/C: 1234 Pack: RXX
DEMY XXX
X_X123_1234.1234 X

(X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X

The diagram shows a rectangular label with rounded corners. It contains the OSRAM logo and product name at the top left. To the right are fields for 'LX XXXX' and 'BIN1: XX-XX-X-XXX-X'. Below this is 'RoHS Compliant'. The main body of the label is divided into three horizontal sections, each with a barcode and associated text: (6P) BATCH NO: 1234567890, (1T) LOT NO: 1234567890, and (X) PROD NO: 123456789(Q)QTY: 9999 (G) GROUP: XX-XX-X-X. A 'Moisture Sensitive Device' symbol (a circle with a diagonal line and three drops) is placed between the first and second sections. To the right of the second section is a square QR code. Additional text 'ML Temp ST X XXX °C X', 'Pack: RXX', 'DEMY XXX', and 'X_X123_1234.1234 X' is interspersed between the sections.

OHA04563

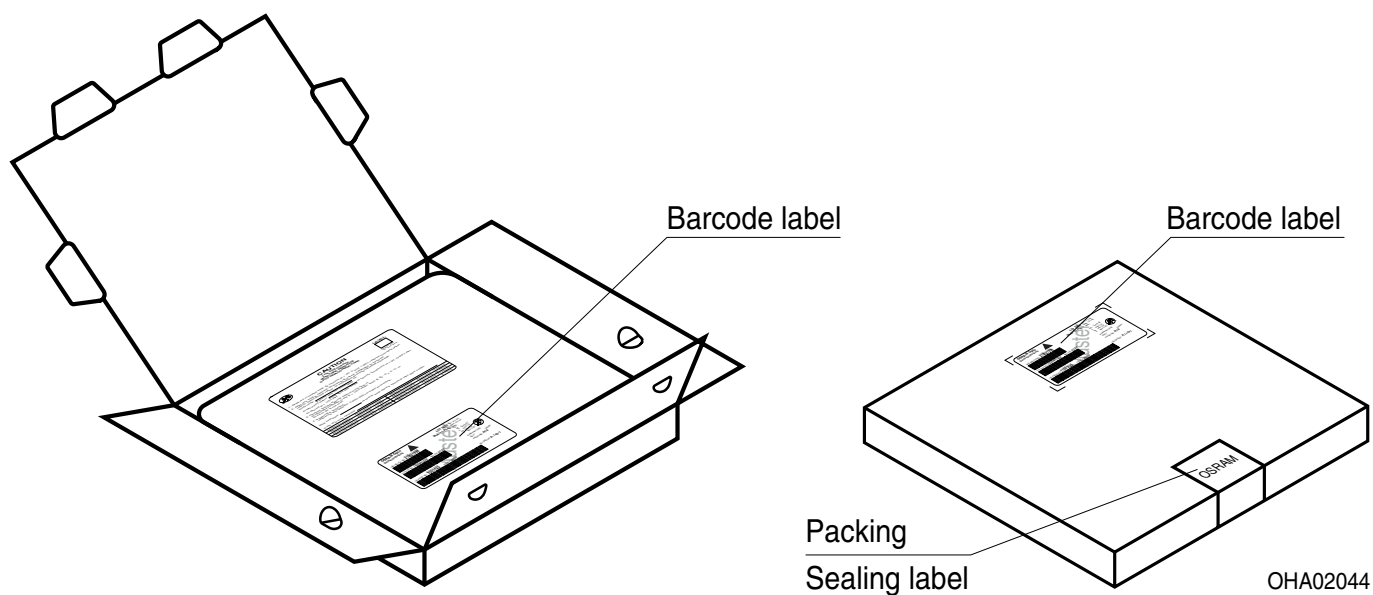
Dry Packing Process and Materials ⁹⁾



OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

Schematic Transportation Box ⁹⁾



Dimensions of Transportation Box

Width

Length

Height

195 ± 5 mm

195 ± 5 mm

30 ± 5 mm

Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.

Glossary

- 1) **Radiant intensity:** Measured at a solid angle of $\Omega = 0.01$ sr
- 2) **Brightness:** The brightness values are measured with a tolerance of $\pm 11\%$.
- 3) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- 4) **Forward Voltage:** The forward voltages are measured with a tolerance of ± 0.1 V.
- 5) **Total radiant flux:** Measured with integrating sphere.
- 6) **Thermal resistance:** junction - soldering point, of the device only, mounted on an ideal heatsink (e.g. metal block)
- 7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 8) **Testing temperature:** TA = 25°C (unless otherwise specified)
- 9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimensions are specified in mm.
- 10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Revision History

Version	Date	Change
1.1	2019-09-26	Ordering Information Characteristics Brightness Groups Electro - Optical Characteristics (Diagrams) Glossary

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此产品符合欧盟 RoHS 指令的要求；
按照中国的相关法规和标准，不含有毒有害物质或元素。

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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